Attorney Docket No. 81872.0051 Customer No. 26021

Appl. No. 10/650,505 Amdt. Dated September 8, 2008 Reply to Office Action of July 1, 2008

## Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

## Listing of Claims:

- 1-12. (Canceled)
- (Currently amended) A method for producing a solar cell comprising:

placing a substrate for a solar cell on an RF electrode provided inside a chamber, directly or through a tray:

covering said substrate with a plate with a distance, wherein said plate is not in direct contact with said substrate, wherein said plate comprises an obstacle with a plurality of obstacle forming members that inhibit a part of gas and plasma from passing through said plate; and

forming textures on a surface of said substrate by using residues being, wherein said residues chiefly composed of comprise components of said substrate as an otching mack.

- 14. (Previously presented) The method for producing a solar cell according to Claim 13, wherein said substrate is made of silicon.
- 15. (Previously presented) The method for producing a solar cell according to Claim 13, wherein said plate covers said substrate while a distance of 5 mm to 30 mm is between the substrate and plate.
  - 16-17. (Canceled)

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18. (Currently amended) A method for producing a solar cell, comprising:

placing a substrate on an RF electrode provided inside a chamber, directly or through a tray:

covering said substrate with a plate with-a distance, wherein said plate is not in direct contact with said substrate, the said plate being provided with a number of opening portions, wherein said plate inhibits a part of gas and plasma from passing through said plate; and

etching the substrate by a reactive ion etching method;

wherein textures are formed on a surface of said substrate <u>by using residues</u>, wherein said residues chiefly comprise components of said substrate, and said plate is cleaned on a surface side concurrently.

19. (Previously presented) The method for producing a solar cell according to Claim 20, wherein said first and second substrates are etched by a reactive ion etching method.

20. (Currently amended) A method for producing a solar cell comprising:

placing a first substrate for a solar cell on an RF electrode provided inside a chamber, directly or through a tray;

covering said first substrate with a plate with a distance, wherein said plate is not in direct contact with said first substrate, said plate being provided with a number of opening portions;

forming textures on a surface of said first substrate and cleaning said plate on a surface side concurrently.

placing a second substrate inside the chamber, with said plate positioned such that the surface side and a back surface side thereof being reversed after said Appl. No. 10/650,505 Amdt. Dated September 8, 2008 Reply to Office Action of July 1, 2008

plate is cleaned on the surface side, and forming textures on a surface of said second substrate.

## 21-22. (Canceled)

- 23. (Previously presented) The method for producing a solar cell according to Claim 13, wherein an opening portion is provided between neighboring obstacle forming members.
- 24. (Previously presented) The method for producing a solar cell according to Claim 23, wherein an open area ratio of said obstacle is 5 to 40%.
- 25. (Previously presented) The method for producing a solar cell according to Claim 13, wherein said obstacle forming members are a plurality of long members aligned with a clearance in between.
- 26. (Previously presented) The method for producing a solar cell according to Claim 25. wherein said long member is a bar-shaped or sheet member.
- 27. (Previously presented) The method for producing a solar cell according to Claim 13, wherein said obstacle forming member comprises a mesh woven by crossing plurality of long members over and under with each other.
- 28. (Previously presented) The method for producing a solar cell according to Claim 13, wherein said obstacle comprises a plurality of obstacles of a stacked structure.

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- 29. (Previously presented) The method for producing a solar cell according to Claim 28, wherein said obstacle comprises a member formed by stacking a plurality of long members aligned with a clearance in between, in different directions.
- 30. (Previously presented) The method for producing a solar cell according to Claim 13, wherein said obstacle forming member is made of one kind or a combination of two or more kinds selected from a group consisting of materials (a), (b). and (c) as follows:
  - (a) a glass-based material;
  - (b) a metal material; and
  - (c) a resin material.
- 31. (Previously presented) The method for producing a solar cell according to Claim 30, wherein said metal material is an aluminum-based material.
- 32. (Previously presented) The method for producing a solar cell according to Claim 18, wherein said plate is structured in such a manner that a surface and a hack surface can be reversed.
- 33. (Previously presented) The method for producing a solar cell according to Claim 32, wherein the surface and the back surface of said plate are of substantially a same shape.
- 34. (Currently amended) A method for producing a solar cell comprising: placing a substrate for a solar cell on an RF electrode provided inside a chamber, directly or through a tray;

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covering said substrate with a plate with a distance, wherein said plate is not in direct contact with said substrate, said plate being provided with a number of opening portions, wherein said plate inhibits a part of a gas and plasma from passing through said plate; and

forming textures on a surface of said substrate by using residues being,
wherein said residues chiefly composed of comprise components of said substrate as
an etching mask.

- 35. (Previously presented) The method for producing a solar cell according to Claim 34, wherein an open area ratio of said obstacle is 5 to 40%.
- 36. (Previously presented) The method for producing a solar cell according to Claim 34, wherein said substrate is made of silicon.
- 37. (Previously presented) The method for producing a solar cell according to Claim 34, wherein said plate covers said substrate while a distance of 5 mm to 30 mm is between the substrate and plate.
  - 38. (Canceled)
- 39. (Previously presented) The method for producing a solar cell according to Claim 34, wherein said obstacle is made of one kind or a combination of two or more kinds selected from a group consisting of materials (a), (b), and (c) as follows:
  - (a) a glass-based material;
    - (b) a metal material; and
    - (c) a resin material.

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- 40. (Previously presented) The method for producing a solar cell according to Claim 39, wherein said metal material is an aluminum-based material.
- 41. (Previously presented) The method for producing a solar cell according to Claim 34, wherein said substrate is etched by a reactive ion etching method.